



PATENTS  
112055-0040P1  
17732-38560.001

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re The Application of:	)	Examiner: Leonardo Andujar
David Chong Sook Lim et al.	)	
	)	Art Unit: 2826
Serial No.: 10/664,982	)	
	)	
Filed: September 17, 2003	)	
	)	
For: PACKAGING SYSTEM FOR DIE-	)	
UP CONNECTION OF A DIE-DOWN	)	
ORIENTED INTEGRATED CIRCUIT	)	

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September 7, 2005

"Express Mail" Mailing-Label Number: EV432397743US

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT**

In response to the Office action dated 05/20/2005, please find a request for an extension of one month and the corresponding fee. Please enter the following amendments: